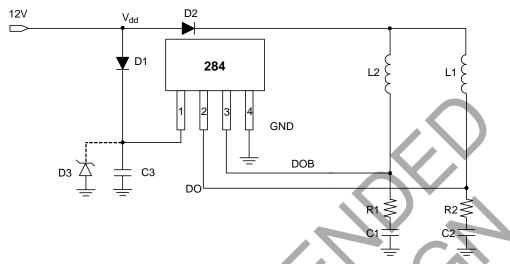


Typical Application Circuit (Note 4)

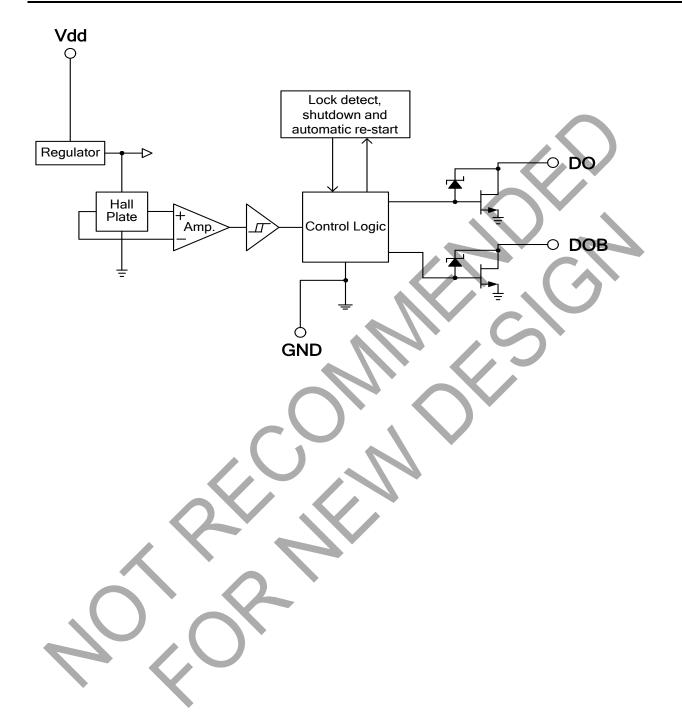


- Note: 4. Typically it is recommended to us a 56Ω resistor for R1 and R2 and a 2.2µF E-Cap capacitor for C1, C2 and C3. These values may need to be optimized depending on the coils used. To help with IC protection it's advised to add a Zener diode between Vdd and ground. The Zener diode should be chosen to help
 - To help with IC protection it's advised to add a Zener diode between Vdd and ground. The Zener diode should be chosen to help prevent the supply voltage exceeding the maximum rating of the device.

Pin Descriptions Pin Name (SOT89-5) Description Vdd Input Power DO Output Pin DOB Output Pin GND Ground NC Not Connected



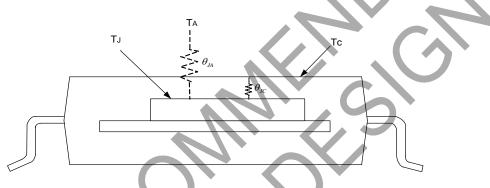
Functional Block Diagram





Absolute Maximum Ratings (T_A = +25°C)

Symbol	Characte	Rating	Unit			
V _{DD}	Supply Voltage			24	V	
I _O Outpu			SIP-4	500	mA	
	Output Current	I _{O(AVE)}	SOT89-5	500	mA	
		I _{O(PEAK)}		700	mA	
D Bower Dissinction	Power Dissipation	SIP-4		550	mW	
PD		SOT89-5		800	mW	
T _{ST}	Storage Temperature	-55 to +150	°C			
TJ	Maximum Junction Temperature	ximum Junction Temperature				
θ _{JA}	Thermal Resistance Junction to Case	SIP-4		227	°C/W	
ÐJA	(Note 5)	SOT89-5		156	°C/W	



Note: 5. θ_{JA} should be confirmed with heat sink thermal resistance. If there is no heat sink contact, θ_{JA} will almost be the same as θ_{JC} .

Recommended Operating Conditions

Symbol	Characteristic	Conditions	Min	Мах	Unit
V _{DD}	Supply Voltage	Operating	3.8	20	V
TA	Operating Ambient Temperature	Operating	-40	+100	°C



Electrical Characteristics ($T_A = +25^{\circ}C$, $V_{DD} = 12V$, unless otherwise specified.)

Symbol	Characteristics	Characteristics Conditions					
I _{DD}	Supply Current	Operating	-	2.0	4.0	mA	
IOFF	Output Leakage Current	$V_{OUT} = 24V$	-	< 0.1	10	μA	
t _{RLP-ON}	Rotor Lock Protection On Time	-	0.4	0.5	0.6	Sec	
t _{RLP-OFF}	Rotor Lock Protection Off Time	-	2.4	3	3.6	Sec	
M	Output Saturation Voltage	I _O = 300mA	-	375	500	mV	
V _{OUT(SAT)}	Output Saturation Voltage	I _O = 500mA	-	625	900	IIIV	
R _{DS(ON)}	Output On Resistance	I _O = 300mA	-	1.25	1.67	Ω	
Vz	Output Zener-Breakdown Voltage	-	35	42	60	V	

Truth Table

IN-	IN+	СТ	OUT1	OUT2	Mode
Н	L	L	н	L	Rotating
L	Н	L	L	Н	Rotating
_	_	Н	Off	Off	Lockup protection activated

Magnetic Characteristics ($T_A = +25^{\circ}C$, $V_{DD} = 12V$, unless otherwise specified, Note 6)

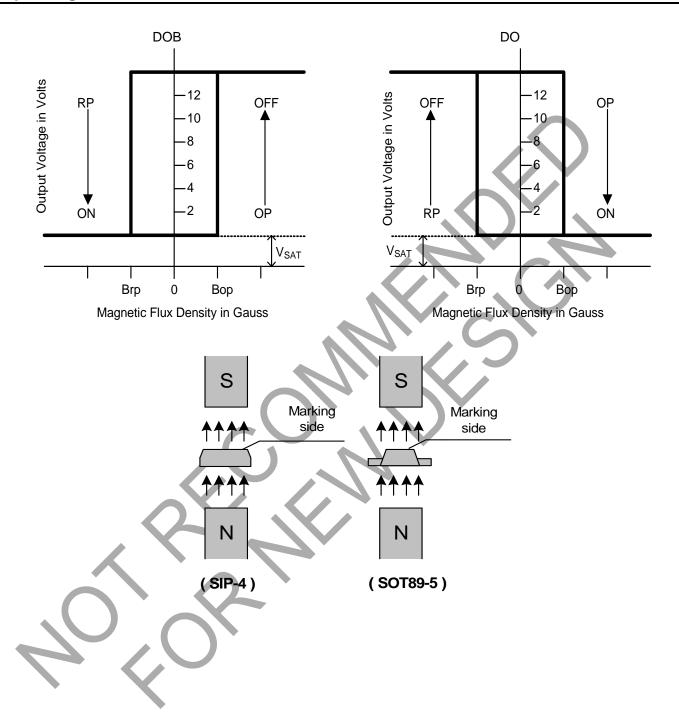
					(1mT = 10 Gauss)
Symbol	Characteristics	Min	Тур.	Max	Unit
Вор	Operation Point	10	30	60	Gauss
Brp	Release Point	-60	-30	-10	Gauss
Bhy	Hysteresis		60	-	Gauss

Note: 6. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.





Operating Characteristics



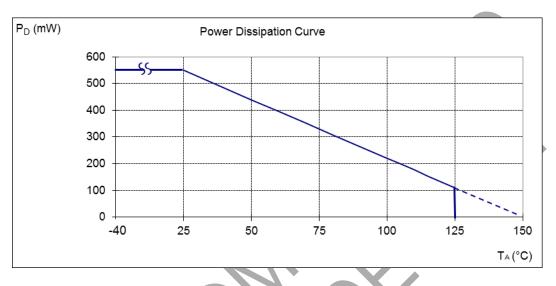


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Performance Characteristics

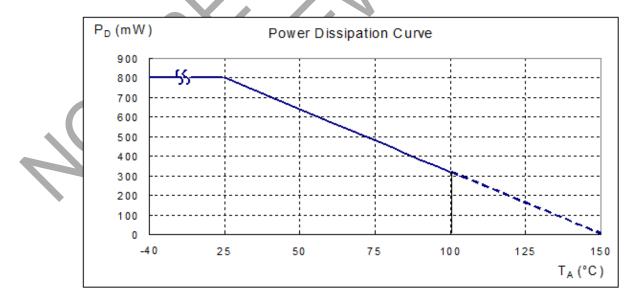
(1) SIP-4

T _A (°C)	25	50	60	70	80	85	90	95	100
P _D (mW)	550	440	396	352	308	286	264	242	220
T _A (°C)	105	110	115	120	125	130	135	140	150
P _D (mW)	198	176	154	132	110	88	66	44	0



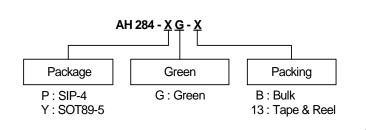
(2) SOT89-5

(2) 001000										
T _A (°C)	25	50	60	70	75	80	85	90	95	100
P _D (mW)	800	640	576	512	480	448	416	384	352	320
T _A (°C)	105	110	115	120	125	130	135	140	145	150
P _D (mW)	288	256	224	192	160	128	96	64	32	0





Ordering Information



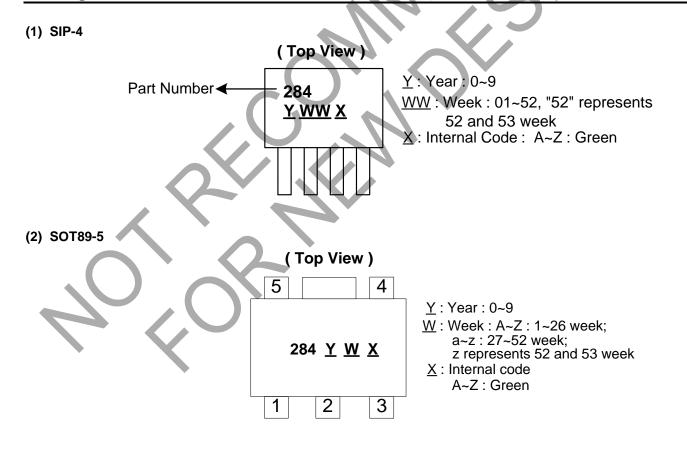
		Baakaga	Backaging	E	lulk	13" Tape a	ind Reel
Device	Status (Note 9)	Package Packaging Code (Note 7, 8)		Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH284-PG-B	NRND	Р	SIP-4	1000	-В	NA	NA
AH284-YG-13	NRND	Y	SOT89-5	NA	NA	2500/Tape & Reel	-13

Notes: 7. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at http://www.diodes.com/package-outlines.html.

8. Reverse taping as shown on Diodes Incorporated's Surface Mount (SMD) Packaging document AP02007, which can be found on our website http://www.diodes.com/datasheets/ap02007.pdf.

9. NRND = Not Recommended for New Design.

Marking Information



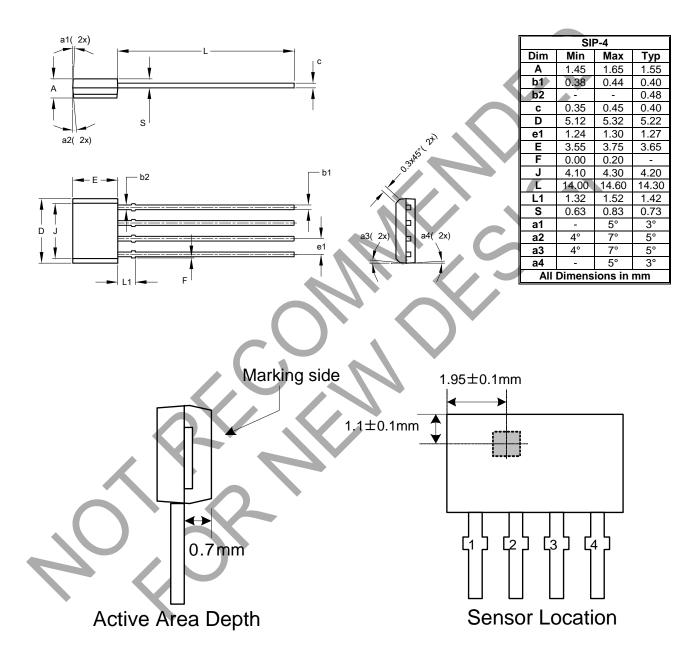


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Package Outline Dimensions (All Dimensions in mm)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SIP-4



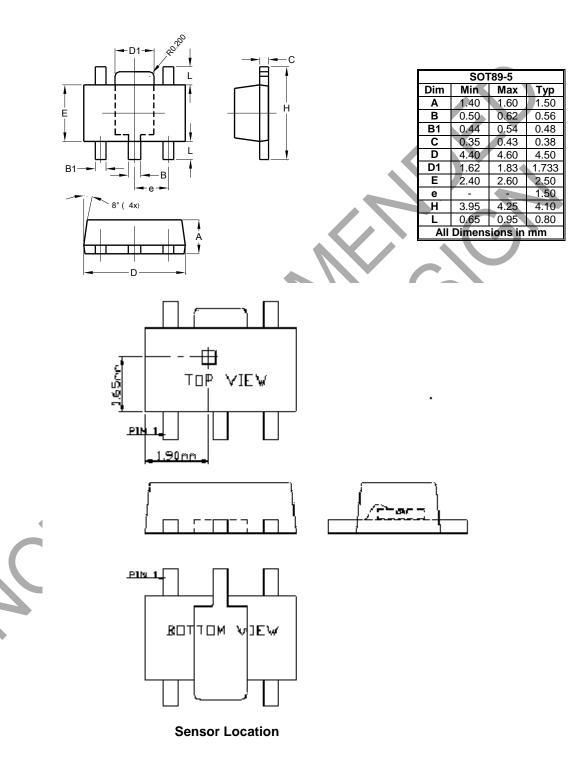


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Package Outline Dimensions (Cont.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SOT89-5





Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89



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